



Schottky Barrier Diode

Features

1. High reliability
2. Low reverse current and low forward voltage



Applications

Low current rectification and high speed switching

Construction

Silicon epitaxial planar

Absolute Maximum Ratings

T_j=25°C

Parameter	Test Conditions	Type	Symbol	Value	Unit
Repetitive peak reverse voltage		1N60	V _{RRM}	40	V
		1N60P	V _{RRM}	45	V
Peak forward surge current	t _p ≤1 s	1N60	I _{FSM}	150	mA
		1N60P	I _{FSM}	500	mA
Forward continuous current	T _a =25°C	1N60	I _F	30	mA
		1N60P	I _F	50	mA
Storage temperature range			T _{stg}	-65~+125	°C

Stresses exceeding maximum ratings may damage the device. Maximum ratings are stress ratings only. Functional operation above the recommended operating conditions is not implied. Extended exposure to stresses above the recommended operating conditions may affect device reliability.

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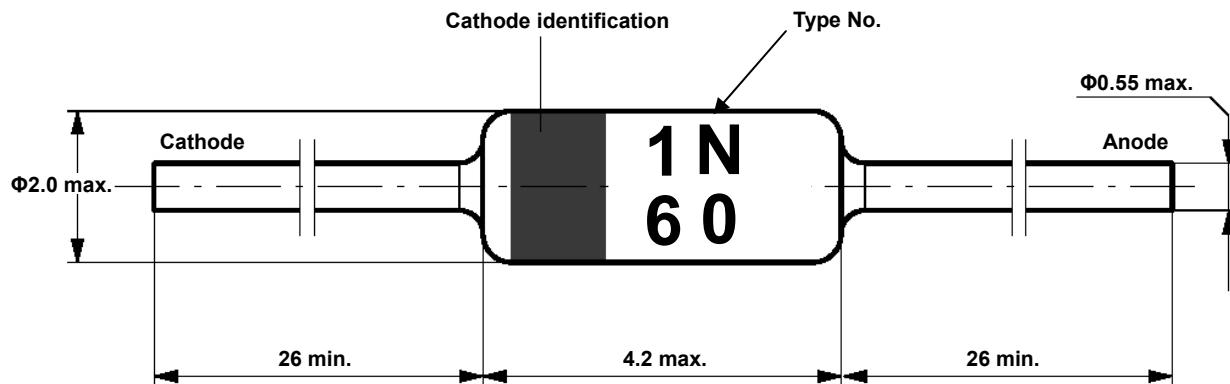
Electrical Characteristics

T_j=25°C

Parameter	Test Conditions	Type	Symbol	Min	Typ	Max	Unit
Forward voltage	I _F =1mA	1N60	V _F		0.32	0.5	V
		1N60P	V _F		0.24	0.5	V
	I _F =30mA	1N60	V _F		0.65	1.0	V
	I _F =200mA	1N60P	V _F		0.65	1.0	V
Reverse current	V _R =15V	1N60	I _R		0.1	0.5	µA
		1N60P	I _R		0.5	1.0	µA
Junction capacitance	V _R =1V, f=1MHz	1N60	C _J		2.0		pF
	V _R =10V, f=1MHz	1N60P	C _J		6.0		pF
Reverse recovery time	I _F =I _R =1mA I _{rr} =1mA R _C =100Ω		t _{rr}			1.0	ns

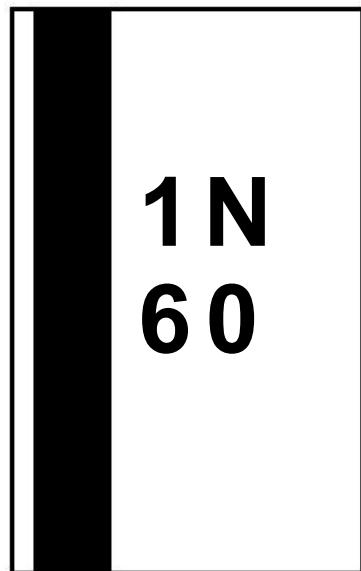


Dimensions in mm



Standard Glass Case
JEDEC DO-35

Marking



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